

Docket No.: H0498.70130US01  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Tao Deng et al.  
Serial No.: 10/763,819  
Confirmation No.: 5026  
Filed: January 23, 2004  
For: FABRICATION OF METALLIC MICROSTRUCTURES VIA  
EXPOSURE OF PHOTSENSITIVE COMPOSITION  
Examiner: K. Duda  
Art Unit: 1795

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being transmitted via the Office electronic filing system in accordance with § 1.6(a)(4).

Dated: 6/4/08

  
Angela M. Griffith

**TRANSMITTAL LETTER**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Enclosed are the following items for filing in connection with the above-referenced Patent Application:

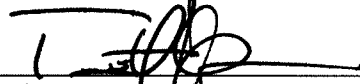
1. Power of Attorney and
2. Statement under 37 C.F.R. 3.73(b).

The Director is hereby authorized to charge any deficiency or credit any overpayment in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper

hereafter filed in this application by this firm) to our Deposit Account No. 23/2825, under Docket No. H0498.70130US01.

Dated: 06/04/02

Respectfully submitted,

By 

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